

Silicon Carbide Power MOSFET

C3M™ MOSFET Technology

N-Channel Enhancement Mode

Features

- · 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- · Halogen free, RoHS compliant

Benefits

- · Reduce switching losses and minimize gate ringing
- Higher system efficiency
- · Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

- Datacenter Power Supplies
- Telecom Power Supplies
- Energy Storage Systems
- Solar (PV) inverters
- High Voltage DC/DC converters

Package

Drain Tab







12345678

	(TAB)
Gate (Pin 1)	\mathbb{Z}
Driver Source (Pin 2)	Power Source (Pin 3,4,5,6,7,8)

Orderable Part Number	Package	Marking
C3M0060065L-TR	TOLL	C3M0060065L

Maximum Ratings (T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V_{DSmax}	Drain - Source Voltage		650	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	٧	Note: 1
1			39	_	Fig. 19
I _D	Continuous Drain Current, V _{GS} = 15 V	T _C = 100°C	25	- A	Note: 2
I _{D(pulse)}	Pulsed Drain Current, Pulse width t _P limited by T _{jmax}	99	А	Fig. 22	
$P_{\scriptscriptstyle D}$	Power Dissipation, T _c =25°C, T _J = 175 °C	131	W	Fig. 20 Note: 2	
T_{J}	Junction Temperature	-40 to +175	°C		
T_{C} , T_{stg}	Case Temperature and Storage Temperature	-40 to +150	°C		
T _L	Solder Temperature, 1.6mm (0.063") from case for 10s	260	°C		

Note (1): Recommended turn off / turn on gate voltage $V_{\rm GS}$ - 4V...0V / +15V

Note (2): Verified by design

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
V _{(BR)DSS}	Drain-Source Breakdown Voltage	650			V	V _{GS} = 0 V, I _D = 100 μA		
V	Cata Thursday Id Walter us	1.8	2.8	3.6	V	V _{DS} = V _{GS} , I _D = 3.64 mA	F: 11	
$V_{GS(th)}$	Gate Threshold Voltage		2.2		V	$V_{DS} = V_{GS}$, $I_{D} = 3.64$ mA, $T_{J} = 175$ °C	Fig. 11	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μΑ	V _{DS} = 650 V, V _{GS} = 0 V		
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V		
D	Drain-Source On-State Resistance		60	79	mΩ	V _{GS} = 15 V, I _D = 13.2 A	Fig. 4,	
R _{DS(on)}	Drain-Source Off-State Nesistance		84		11152	V _{GS} = 15 V, I _D = 13.2 A, T _J = 175°C	5, 6	
	Transconductance		9		S	V _{DS} = 20 V, I _{DS} = 13.2 A	Fig. 7	
g _{fs}	Transconductance		9			V _{DS} = 20 V, I _{DS} = 13.2 A, T _J = 175°C	Trig. /	
C _{iss}	Input Capacitance		1170			V _{GS} = 0 V, V _{DS} = 400 V		
Coss	Output Capacitance		72	İ	pF	V _{GS} = 0 V, V _{DS} = 400 V F = 1 Mhz	Fig. 17, 18	
C _{rss}	Reverse Transfer Capacitance		6	†		Vac = 25 mV		
E _{oss}	C _{oss} Stored Energy		14		μJ	V _{DS} = 600 V, F = 1 Mhz		
$C_{\text{o(er)}}$	Effective Output Capacitance (Energy Related)		85		pF	V 0VV 0 400V		
C _{o(tr)}	Effective Output Capacitance (Time Related)		122		pF	$V_{GS} = 0 \text{ V, } V_{DS} = 0 400 \text{ V}$	Note: 3	
Eon	Turn-On Switching Energy (Body Diode FWD)		28		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 13.24$			
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		11		μJ	$R_{G(ext)} = 2.5 \Omega$, L= 135 μ H, $T_J = 25^{\circ}$ C FWD = Internal Body Diode	Fig. 23	
t _{d(on)}	Turn-On Delay Time		6					
t _r	Rise Time 8			1	$V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 13.2 \text{ A}, R_{G(ext)} = 2.5 \Omega,$	F: 06		
t _{d(off)}	Turn-Off Delay Time		14		ns	Timing relative to V _{DS}	Fig. 26	
t _f	Fall Time		7		1	inductive load		
R _{G(int)}	Internal Gate Resistance		4		Ω	f = 1 MHz, V _{AC} = 25 mV		
Q _{gs}	Gate to Source Charge		16			V _{DS} = 400 V, V _{GS} = -4 V/15 V		
Q_{gd}	Gate to Drain Charge		12		nC I _D = 13.2 A		Fig. 12	
Qg	Total Gate Charge		46			Per IEC60747-8-4 pg 21		

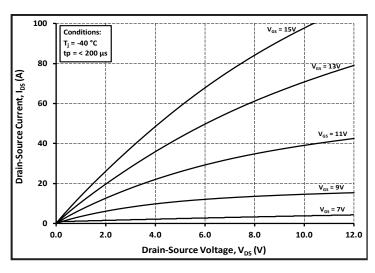
Note (3): Co(en), a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 400V Co(tr), a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 400V

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V	Die de France d Welteren	4.6		٧	$V_{GS} = -4 \text{ V, I}_{SD} = 6.6 \text{ A, T}_{J} = 25 \text{ °C}$	Fig. 8,
V_{SD}	Diode Forward Voltage	4.1		٧	V _{GS} = -4 V, I _{SD} = 6.6 A, T _J = 175 °C	9, 10
Is	Continuous Diode Forward Current		22	Α	V _{GS} = -4 V, T _C = 25°C	
I _{S, pulse}	Diode pulse Current		99	Α	V_{GS} = -4 V, pulse width t_P limited by T_{jmax}	
t _{rr}	Reverse Recover time	9		ns		
Q _{rr}	Reverse Recovery Charge	142		nC	$V_{GS} = -4 \text{ V, } I_{SD} = 13.2 \text{ A, } V_{R} = 400 \text{ V}$ dif/dt = 5570 A/ μ s, $T_{J} = 25 \text{ °C}$	
I _{rrm}	Peak Reverse Recovery Current	33		Α		
t _{rr}	Reverse Recover time	10		ns		
Q _{rr}	Reverse Recovery Charge	60		nC	V _{GS} = -4 V, I _{SD} = 13.2 A, V _R = 400 V dif/dt = 2160 A/μs, Τ _r = 25 °C	
I _{rrm}	Peak Reverse Recovery Current	10		А	a., at 2.007, 40, 1, 20 0	

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
$R_{ heta JC}$	Thermal Resistance from Junction to Case	0.89	°C/W		Fig. 21



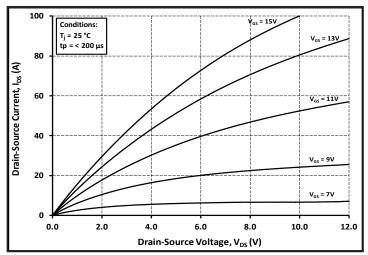
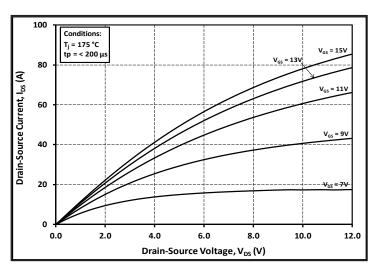


Figure 1. Output Characteristics T_J = -40 °C





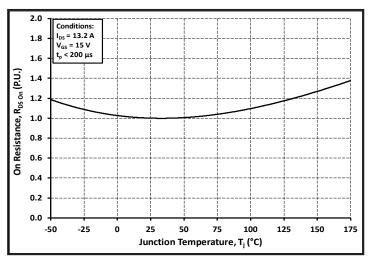
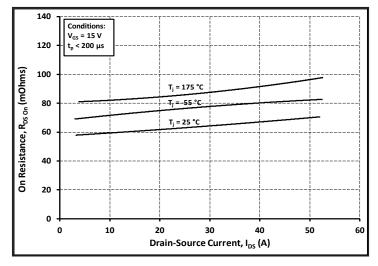


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



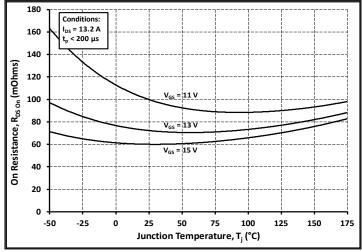


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

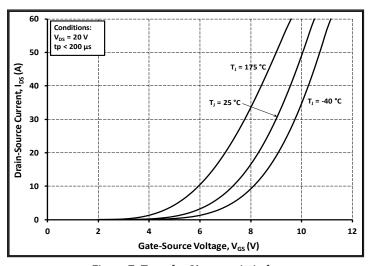


Figure 7. Transfer Characteristic for Various Junction Temperatures

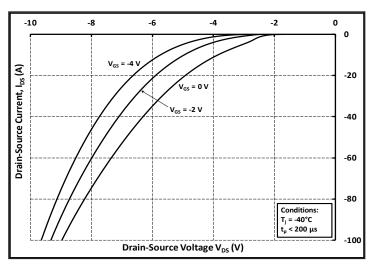


Figure 8. Body Diode Characteristic at -40 °C

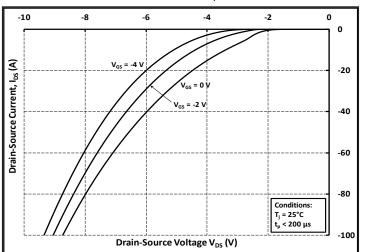


Figure 9. Body Diode Characteristic at 25 °C

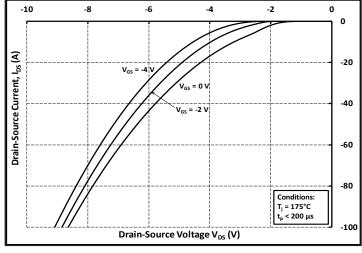


Figure 10. Body Diode Characteristic at 175 °C

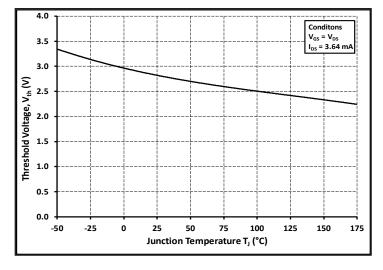


Figure 11. Threshold Voltage vs. Temperature

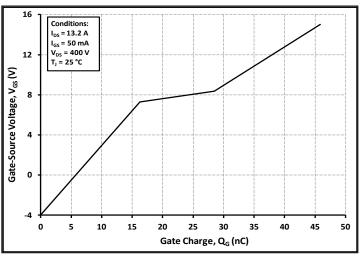
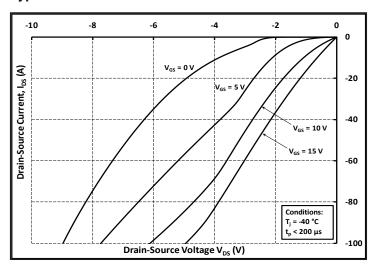
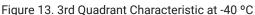


Figure 12. Gate Charge Characteristics





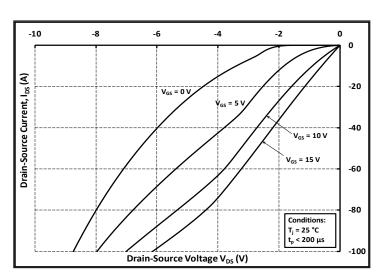


Figure 14. 3rd Quadrant Characteristic at 25 °C

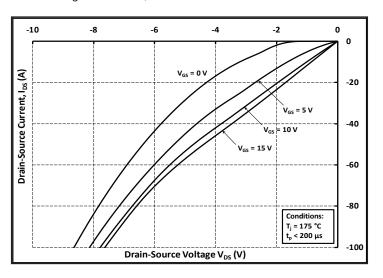


Figure 15. 3rd Quadrant Characteristic at 175 °C

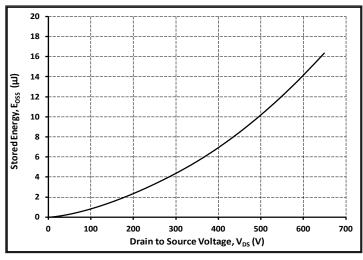


Figure 16. Output Capacitor Stored Energy

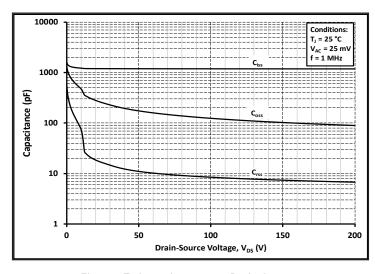


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

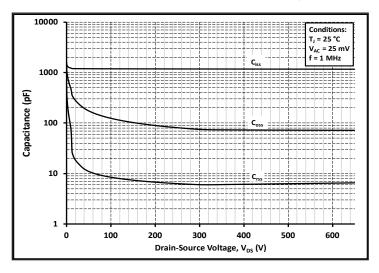
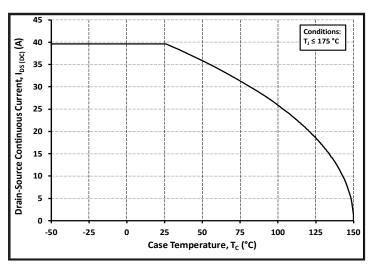


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)



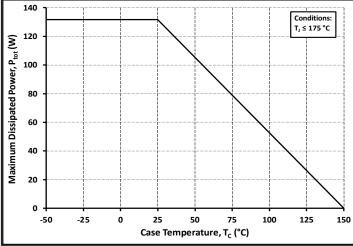
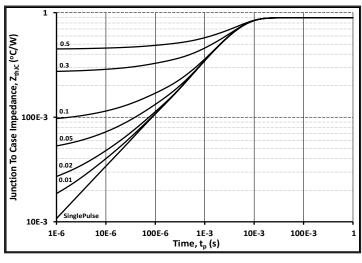


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

Figure 20. Maximum Power Dissipation Derating vs.

Case Temperature



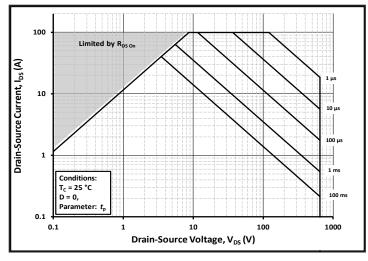
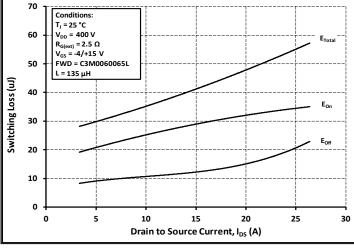


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



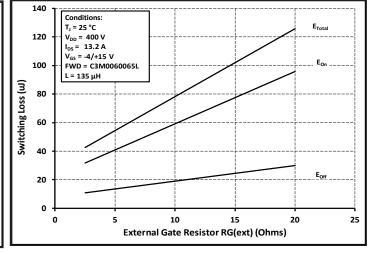


Figure 23. Clamped Inductive Switching Energy vs. Drain Current $(V_{DD} = 400V)$

Figure 24. Clamped Inductive Switching Energy vs. $R_{\rm G(ext)}$

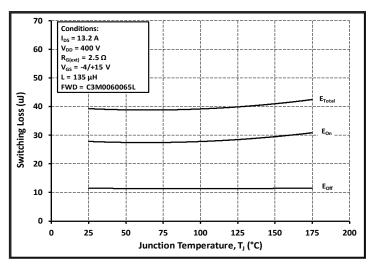


Figure 25. Clamped Inductive Switching Energy vs.
Temperature

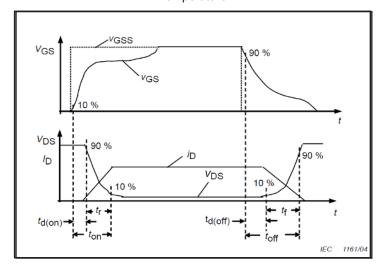


Figure 27. Switching Times Definition

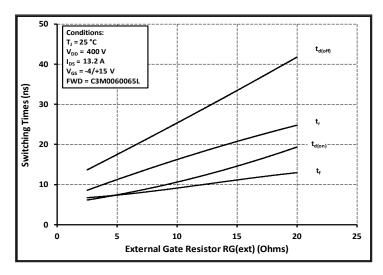


Figure 26. Switching Times vs. $R_{G(ext)}$

Test Circuit Schematic

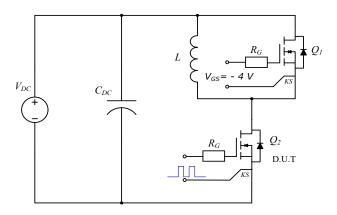
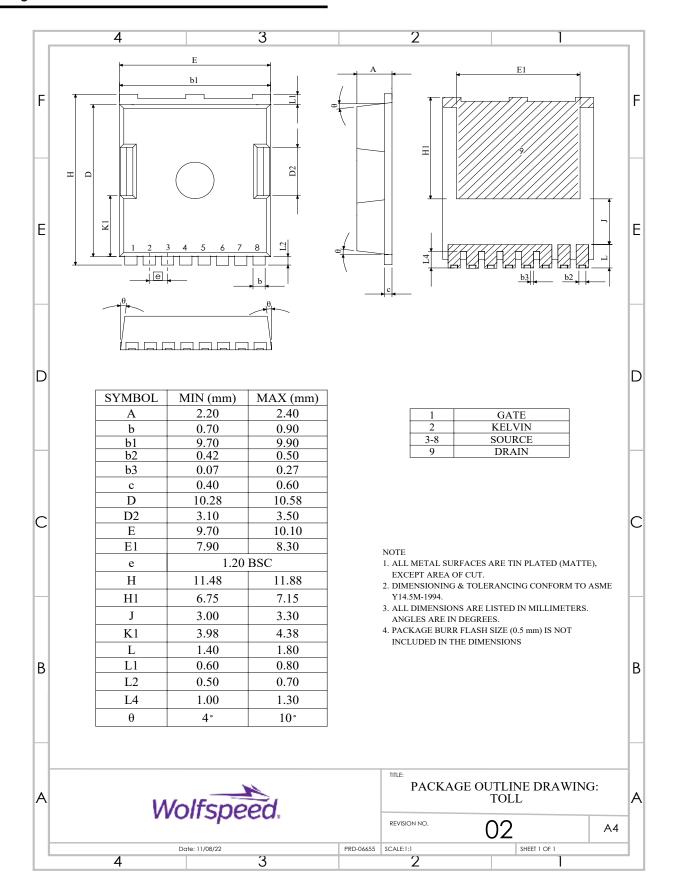


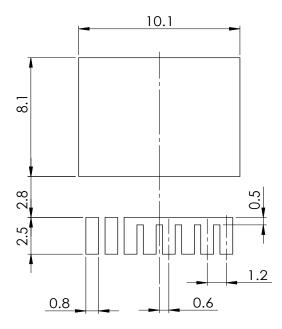
Figure 28. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout

(Note: All Dimensions are listed in Millimeters)



Revision history

Document Version	Date of release	Description of changes
1.0	September-2022	Initial datasheet
2.0	November-2022	Correction in the placement of "E1" package dimension Orderable part number information added

C3M0060065L 1.

Notes & Disclaimer

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